



# Datasheet

## X3USN0154X0TL3-B

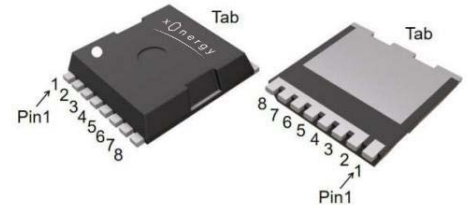
## Contents

- Features 1
- Maximum Ratings 2
- Electrical Characteristics 3
- Package Dimensions 8
- Revision History 10
- – Applications 1
- – Thermal Characteristics 2
- – Characteristics Diagrams 4
- – Important Notice 9

### Features

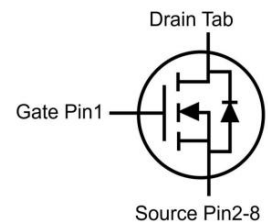
| $V_{DS}$ | $R_{DS(on)}@V_{GS}=10V$ | $I_D$ |
|----------|-------------------------|-------|
| 150V     | 3.0m $\Omega$           | 250A  |

- Excellent FoM
- Low  $R_{DS(on)}$  to minimize conduction losses
- 100%  $\Delta V_{DS}$ , UIS &  $R_g$  Tested



### Applications

- Hard Switching and High Speed Circuit
- Synchronous Rectification in SMPS
- DC/DC in Telecoms and Industrial



**HF** Halogen-Free



| Type             | Package | Qty  |
|------------------|---------|------|
| X3USN0154X0TL3-B | TOLL    | 2000 |

## Maximum Ratings ( $T_c=25^{\circ}\text{C}$ unless otherwise specified)

| Symbol         | Parameter                                                          |                             | Rating     | Unit               |
|----------------|--------------------------------------------------------------------|-----------------------------|------------|--------------------|
| $V_{(BR)DSS}$  | Drain-Source Breakdown Voltage                                     |                             | 150        | V                  |
| $V_{GS}$       | Gate-Source Voltage                                                |                             | $\pm 20$   | V                  |
| $I_S$          | Diode Continuous Forward Current (Wire bond limited)               | $T_c = 25^{\circ}\text{C}$  | 250        | A                  |
| $I_D$          | Continuous Drain Current @ $V_{GS}=10\text{V}$ (Wire bond limited) | $T_c = 25^{\circ}\text{C}$  | 250        | A                  |
|                | Continuous Drain Current @ $V_{GS}=10\text{V}$ (Silicon limited)   | $T_c = 25^{\circ}\text{C}$  | 286        | A                  |
|                |                                                                    | $T_c = 100^{\circ}\text{C}$ | 201        | A                  |
| $I_{DM}$       | Pulse Drain Current Tested ①                                       | $T_c = 25^{\circ}\text{C}$  | 1165       | A                  |
| $E_{AS}$       | Maximum Avalanche Energy, Single Pulsed ②                          |                             | 1600       | mJ                 |
| $P_D$          | Maximum Power Dissipation ③                                        | $T_c = 25^{\circ}\text{C}$  | 600        | W                  |
| $P_{DSM}$      | Maximum Power Dissipation ④                                        | $T_A = 25^{\circ}\text{C}$  | 3.6        | W                  |
| $T_J, T_{STG}$ | Operating Junction and Storage Temperature Range                   |                             | -55 to 175 | $^{\circ}\text{C}$ |

## Thermal Characteristics

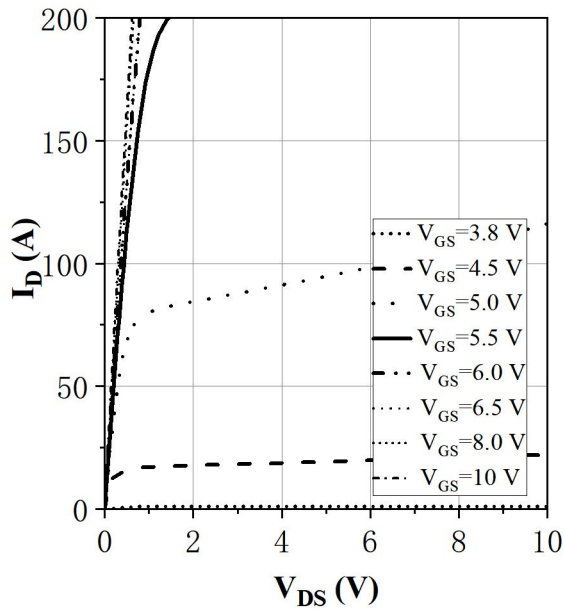
| Symbol          | Parameter                                 | Typical | Max  | Unit                        |
|-----------------|-------------------------------------------|---------|------|-----------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case ⑤    | 0.14    | 0.25 | $^{\circ}\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient ⑥ | 31      | 42   | $^{\circ}\text{C}/\text{W}$ |

## Electrical Characteristics

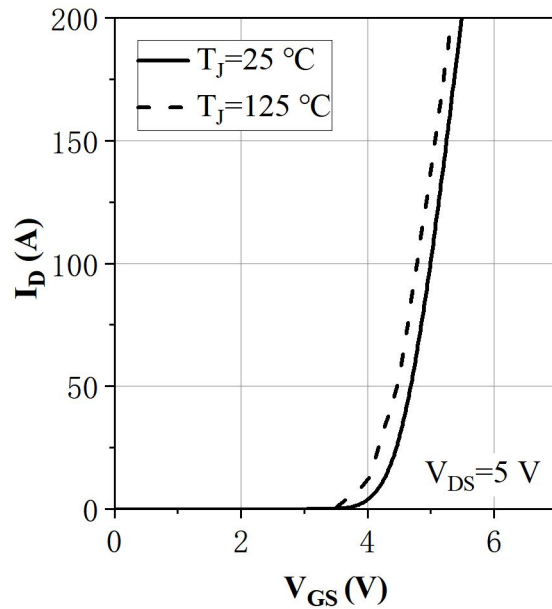
| Symbol                                                                               | Parameter                                               | Condition                                                                                      | Min. | Typ.  | Max. | Unit |
|--------------------------------------------------------------------------------------|---------------------------------------------------------|------------------------------------------------------------------------------------------------|------|-------|------|------|
| Static Electrical Characteristics @ T <sub>J</sub> =25°C (unless otherwise stated)   |                                                         |                                                                                                |      |       |      |      |
| V(BR)DSS                                                                             | Drain-Source Breakdown Voltage                          | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                                                     | 150  | --    | --   | V    |
| I <sub>DSS</sub>                                                                     | Zero Gate Voltage Drain Current (T <sub>J</sub> =25°C)  | V <sub>DS</sub> =150V, V <sub>GS</sub> =0V                                                     | --   | --    | 1    | μA   |
|                                                                                      | Zero Gate Voltage Drain Current (T <sub>J</sub> =125°C) | V <sub>DS</sub> =150V, V <sub>GS</sub> =0V                                                     | --   | --    | 100  | μA   |
| I <sub>GSS</sub>                                                                     | Gate-Body Leakage Current                               | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                                     | --   | --    | ±100 | nA   |
| V <sub>GS(th)</sub>                                                                  | Gate Threshold Voltage                                  | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                       | 2.5  | 3.2   | 4.5  | V    |
| R <sub>DS(on)</sub>                                                                  | Drain-Source On-State Resistance                        | V <sub>GS</sub> =10V, I <sub>D</sub> =20A                                                      | --   | 3.0   | 4.0  | mΩ   |
|                                                                                      |                                                         | (T <sub>J</sub> = 100°C)                                                                       | --   | 4.9   | --   | mΩ   |
| Dynamic Electrical Characteristics @ T <sub>J</sub> = 25°C (unless otherwise stated) |                                                         |                                                                                                |      |       |      |      |
| C <sub>iss</sub>                                                                     | Input Capacitance                                       | V <sub>DS</sub> =75V,V <sub>GS</sub> =0V,<br>f=1MHz                                            | --   | 11189 | --   | pF   |
| C <sub>oss</sub>                                                                     | Output Capacitance                                      |                                                                                                | --   | 734   | --   | pF   |
| C <sub>rss</sub>                                                                     | Reverse Transfer Capacitance                            |                                                                                                | --   | 19.7  | --   | pF   |
| R <sub>g</sub>                                                                       | Gate Resistance                                         | f=1MHz                                                                                         | --   | 4.33  | --   | Ω    |
| Q <sub>g</sub>                                                                       | Total Gate Charge                                       | V <sub>DS</sub> =75V,I <sub>D</sub> =20A,<br>V <sub>GS</sub> =10V                              | --   | 56.0  | --   | nC   |
| Q <sub>gs</sub>                                                                      | Gate-Source Charge                                      |                                                                                                | --   | 20.0  | --   | nC   |
| Q <sub>gd</sub>                                                                      | Gate-Drain Charge                                       |                                                                                                | --   | 19.0  | --   | nC   |
| Switching Characteristics                                                            |                                                         |                                                                                                |      |       |      |      |
| T <sub>d(on)</sub>                                                                   | Turn-On Delay Time                                      | V <sub>DD</sub> =75V,<br>I <sub>D</sub> =20A,<br>R <sub>G</sub> =3.9Ω,<br>V <sub>GS</sub> =10V | --   | 25.5  | --   | ns   |
| T <sub>r</sub>                                                                       | Turn-On Rise Time                                       |                                                                                                | --   | 14.9  | --   | ns   |
| T <sub>d(off)</sub>                                                                  | Turn-Off Delay Time                                     |                                                                                                | --   | 106.0 | --   | ns   |
| T <sub>f</sub>                                                                       | Turn-Off Fall Time                                      |                                                                                                | --   | 18.1  | --   | ns   |
| Source- Drain Diode Characteristics@ T <sub>J</sub> = 25°C (unless otherwise stated) |                                                         |                                                                                                |      |       |      |      |
| V <sub>SD</sub>                                                                      | Forward on Voltage                                      | I <sub>SD</sub> =20A, V <sub>GS</sub> =0V                                                      | --   | 0.77  | 1    | V    |
| T <sub>rr</sub>                                                                      | Reverse Recovery Time                                   | V <sub>DD</sub> =75V<br>I <sub>SD</sub> =20A, V <sub>GS</sub> =0V di/<br>dt=110 A/μs           | --   | 127   | --   | ns   |
| Q <sub>rr</sub>                                                                      | Reverse Tecovery Charge                                 |                                                                                                | --   | 517   | --   | nC   |

- NOTE: ① This current is calculated on single pulse with 10us Pulse & Duty Cycle =10%
- ② This maximum value is based on starting  $T_J=25^{\circ}\text{C}$ ,  $L=0.5\text{mH}$ ,  $R_G=25\Omega$ ,  $I_{AS}=80A$ ,  $V_{GS}=10V$ ; 100% FT tested at  $L=0.5\text{mH}$ ,  $I_{AS}=40A$ .
- ③ The power dissipation  $P_d$  is based on  $T_J(\text{max})$ , using junction-to-case thermal resistance  $R_{\theta JC}$ .
- ④ The power dissipation  $P_{dsM}$  is based on  $T_J(\text{max})$ , using junction-to-ambient thermal resistance  $R_{\theta JA}$ .
- ⑤ Thermal resistance from junction to soldering point (on the exposed drain pad). These tests are performed on a cool plate.
- ⑥ The value of  $R_{\theta JA}$  is measured with the device in a still air environment with  $T_A=25^{\circ}\text{C}$ .

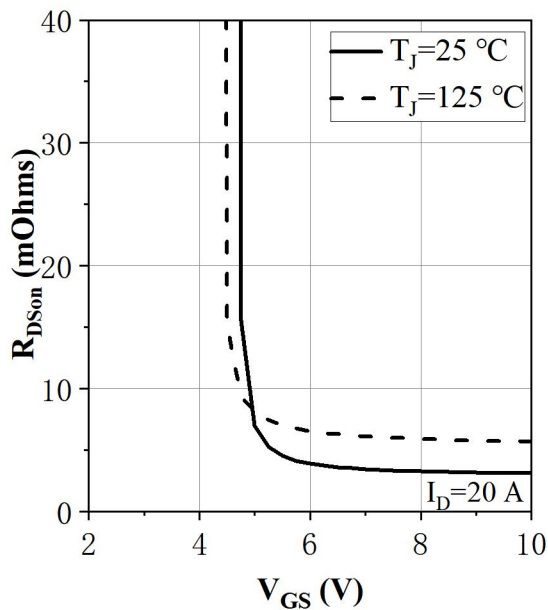
## Characteristics Diagrams



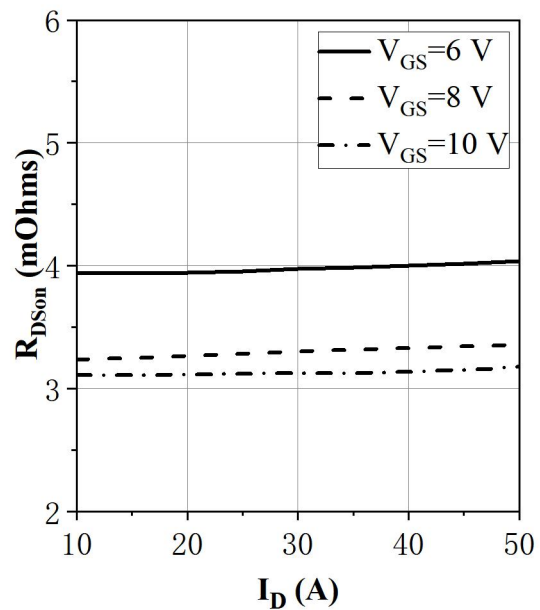
**Fig 1. Output Characteristics**



**Fig 2. Transfer Characteristics**



**Fig 3. On-Resistance vs. Gate-Source Voltage**



**Fig 4. On-Resistance vs. Drain Current**

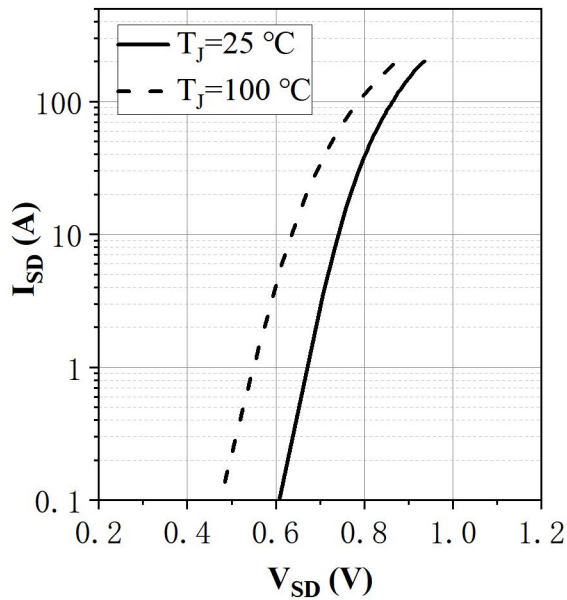


Fig 5. Source-Drain Diode Forward Voltage

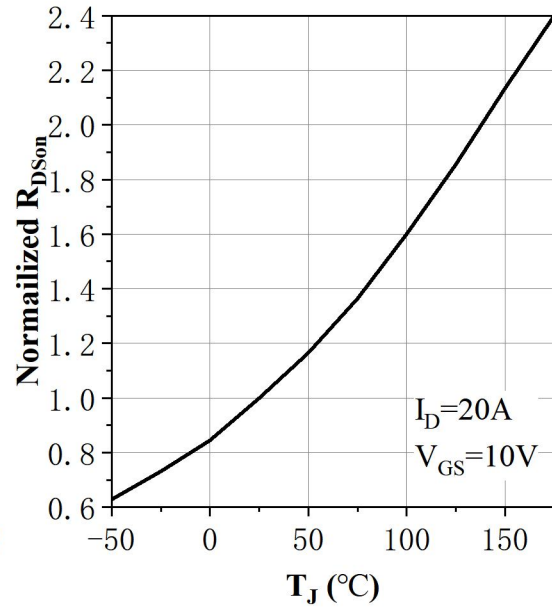


Fig 6. On-Resistance vs. Junction Temperature

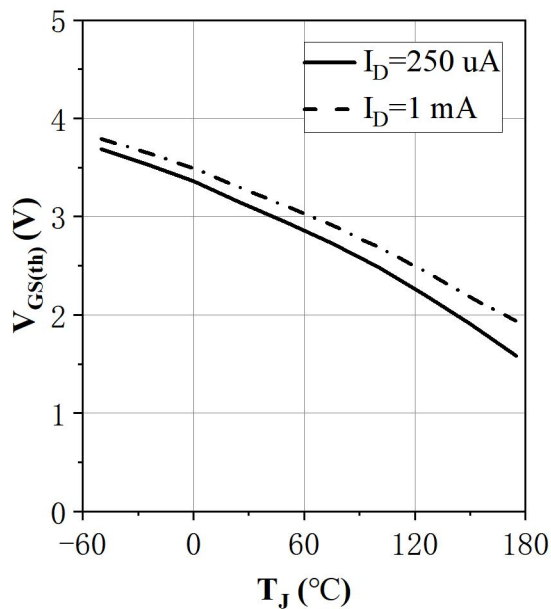


Fig 7. Gate Threshold Variation vs. Junction Temperature

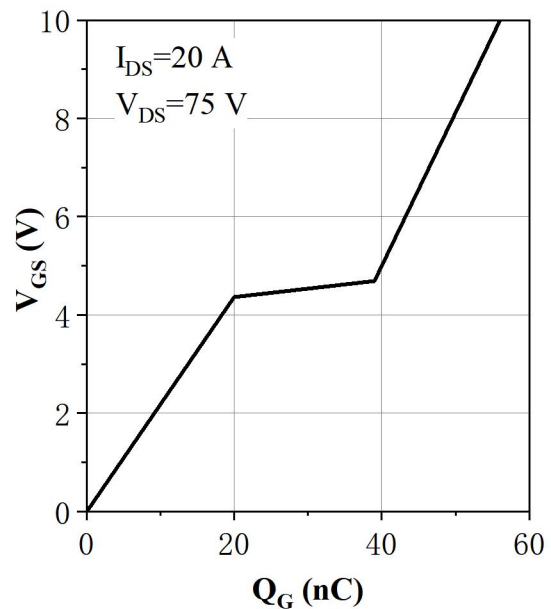


Fig 8. Gate Charge Characteristics

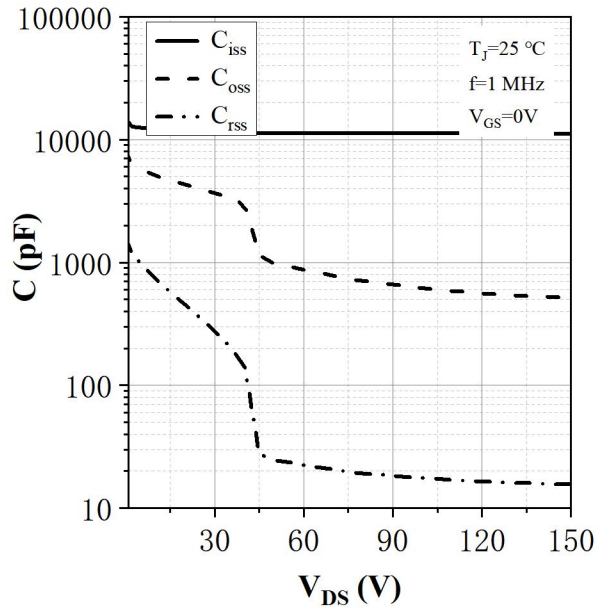


Fig 9. Capacitance Characteristics

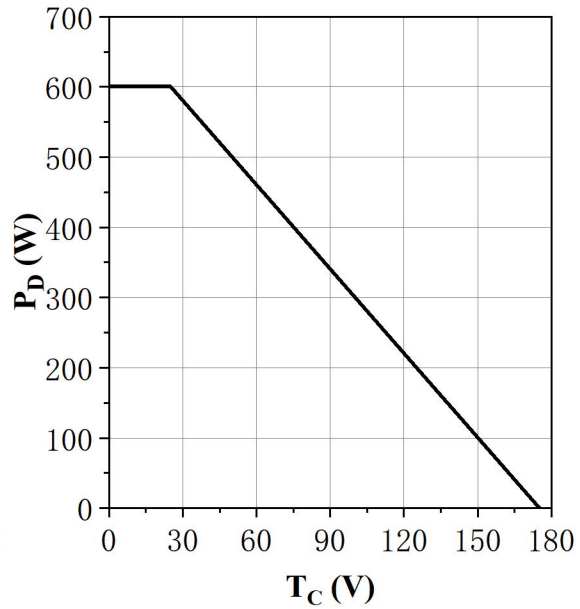


Fig 10. Power Derating

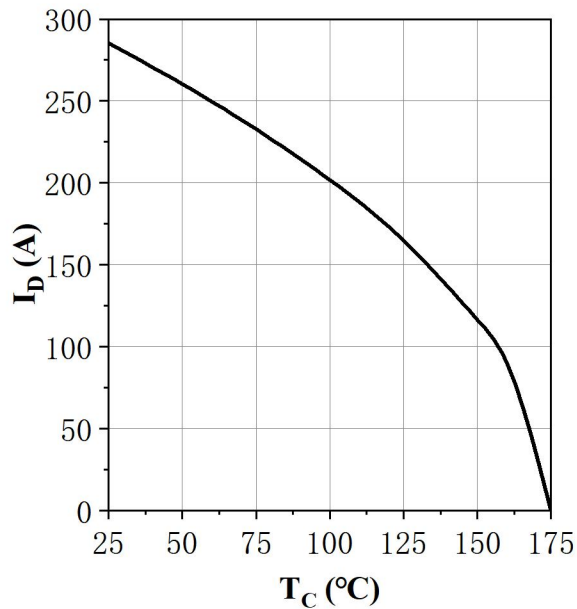


Fig 11. Current Derating

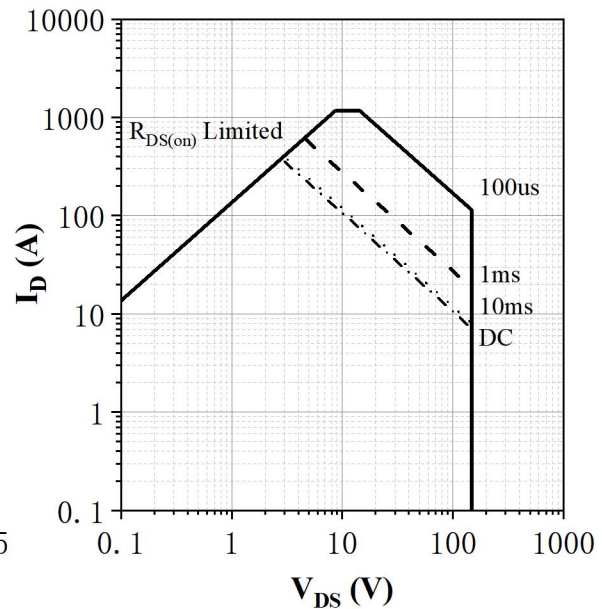


Fig 12. Safe Operating Area

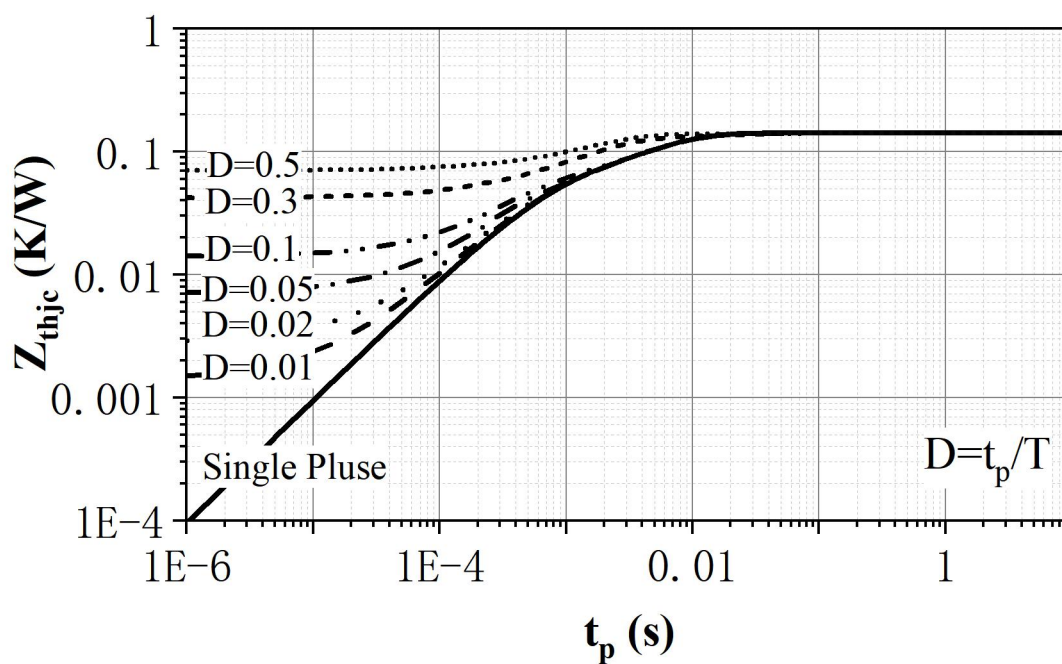
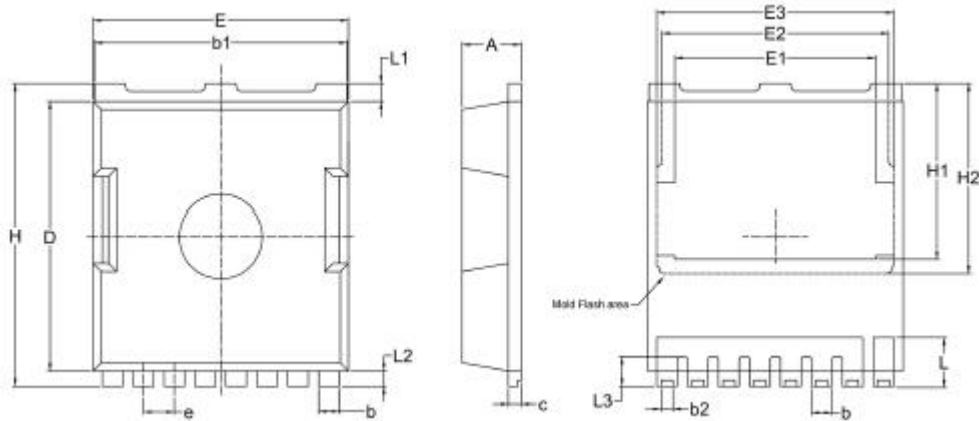


Fig 13. Normalized Maximum Transient Thermal Impedance

## Package Dimensions



### Notes:

1. All dimensions are in mm, angles in degrees.
2. Dimensions do not include mold flash protrusions or gate burrs.

| Symbol | DIMENSIONS ( unit : mm ) |       |       | Symbol | DIMENSIONS ( unit : mm ) |       |       |
|--------|--------------------------|-------|-------|--------|--------------------------|-------|-------|
|        | Min                      | Typ   | Max   |        | Min                      | Typ   | Max   |
| A      | 2.20                     | 2.30  | 2.40  | E3     | --                       | 9.20  | --    |
| b      | 0.70                     | 0.80  | 0.90  | e      | 1.20 BSC                 |       |       |
| b1     | 9.70                     | 9.80  | 9.90  | H      | 11.58                    | 11.68 | 11.78 |
| b2     | 0.42                     | 0.46  | 0.50  | H1     | 6.65                     | 6.75  | 6.85  |
| c      | 0.492                    | 0.500 | 0.508 | H2     | --                       | 7.30  | --    |
| D      | 10.28                    | 10.38 | 10.48 | L      | 1.70                     | 1.90  | 2.10  |
| E      | 9.80                     | 9.90  | 10.00 | L1     | --                       | 0.70  | --    |
| E1     | --                       | 7.80  | --    | L2     | --                       | 0.60  | --    |
| E2     | --                       | 8.80  | --    | L3     | 1.05                     | 1.15  | 1.25  |



X3USN0154X0TL3-B

150V N-Channel Advanced Power MOSFET

## Revision History

| Document revision | Date      | Description of changes |
|-------------------|-----------|------------------------|
| 1.0               | 2025.6.25 | Target datasheet       |
|                   |           |                        |
|                   |           |                        |



X3USN0154X0TL3-B

150V N-Channel Advanced Power MOSFET

---

## Important Notice

The information provided in this document is for informational purposes only and should not be construed as a warranty of condition, character, or performance under any circumstances. Xienergy disclaims any liability arising from the application or use of any of the products described herein, including but not limited to any personal injury, death, or damage to property or the environment. No license, patent or any other intellectual property rights are granted or transferred. Xienergy reserves the right to amend without prior notice. All rights reserved.

### Questions?

Email: [info@xienergy.com](mailto:info@xienergy.com)

Web: [www.xienergy.com](http://www.xienergy.com)

Tel: 1-778.588.1119

Copyright © 2024

Xienergy Systems, Inc.

Vancouver, Canada